

Features

- · Split Gate Trench MOSFET Technology
- · Low Thermal Resistance
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

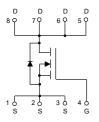
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 3°C/W Junction to Case (2)

| Parameter | Symbol | Rating | Unit |
|--------------------------|-----------------|--------|------|
| Drain-Source Voltage | V _{DS} | 120 | V |
| Gate-Source Volltage | V _{GS} | ±20 | V |
| Continuous Drain Current | I _D | 30 | Α |
| Pulsed Drain Current (3) | I _{DM} | 100 | Α |
| Total Power Dissipation | P_{D} | 41 | W |

Note:

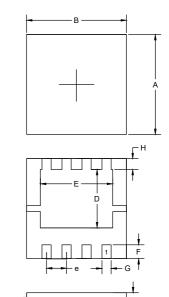
- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. Surface Mounted on 1 in² Pad Area, t≤10 sec.
- 3. Pulse Test: Pulse Width≤10µs, Duty Cycle ≤1%.

Internal Structure



N-CHANNEL MOSFET

DFN3333



| | DIMENSIONS | | | | |
|-------|------------|-------|------|------|------|
| DIM | INCHES | | MM | | NOTE |
| ווועו | MIN | MAX | MIN | MAX | NOTE |
| Α | 0.126 | 0.130 | 3.20 | 3.30 | |
| В | 0.126 | 0.130 | 3.20 | 3.30 | |
| С | 0.030 | 0.033 | 0.75 | 0.85 | |
| C1 | 0.007 | 0.009 | 0.18 | 0.22 | |
| C2 | | 0.002 | | 0.05 | |
| D | 0.071 | 0.079 | 1.80 | 2.00 | |
| Е | 0.087 | 0.098 | 2.20 | 2.50 | |
| F | 0.016 | 0.020 | 0.40 | 0.50 | |
| G | 0.010 | 0.014 | 0.25 | 0.35 | |
| Н | 0.012 | 0.016 | 0.30 | 0.40 | |
| е | 0.024 | 0.028 | 0.60 | 0.70 | |

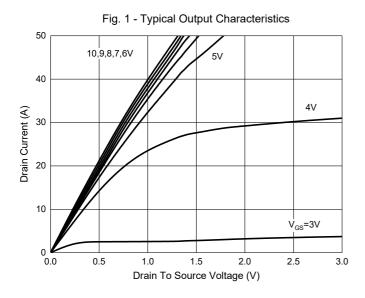


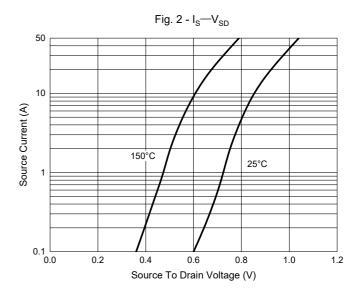
Electrical Characteristics @ 25°C (Unless Otherwise Specified)

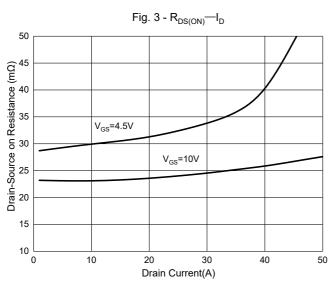
| Parameter | Symbol | Test Conditions | Min | Тур | Max | Unit | |
|---------------------------------|----------------------|---|-----|------|------|------|--|
| Static Characteristics | | | 1 | 1 | 1 | I | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | V _{GS} =0V, I _D =250μA | 120 | | | V | |
| Gate-Source Leakage Current | I _{GSS} | V _{DS} =0V, V _{GS} =±20V | | | ±100 | nA | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =96V, V _{GS} =0V | | | 1 | μA | |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS}=V_{GS}$, $I_{D}=250\mu A$ | 1 | | 3 | V | |
| | В | V _{GS} =10V, I _D =20A | | 23.5 | 28.2 | mΩ | |
| Drain-Source On-Resistance | R _{DS(on)} | V _{GS} =4.5V, I _D =10A | | 31 | 38.7 | mΩ | |
| Diode Characteristics | | | • | | | | |
| Continuous Body Diode Current | Is | | | | 30 | Α | |
| Diode Forward Voltage | V _{SD} | V _{GS} =0V, I _S =20A | | | 1.3 | V | |
| Reverse Recovery Time | t _{rr} | L 00A 1771 400A/m | | 70 | | ns | |
| Reverse Recovery Charge | Q _{rr} | I _S =20A,di/dt=100A/µs | | 192 | | nC | |
| Dynamic Characteristics | | | , | | • | | |
| Input Capacitance | C _{iss} | | | 1028 | | | |
| Output Capacitance | C _{oss} | V _{DS} =60V,V _{GS} =0V,f=1MHz | | 135 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 28 | | | |
| Total Gate Charge | Qg | | | 22.5 | | | |
| Gate-Source Charge | Q _{gs} | V _{DS} =60V,V _{GS} =10V,I _D =20A | | 5.2 | | nC | |
| Gate-Drain Charge | Q_{gd} | | | 5.1 | | | |
| Turn-On Delay Time | t _{d(on)} | | | 6.6 | | | |
| Turn-On Rise Time | t _r | V_{DS} =60V, V_{GEN} =10V, R_G =4.5 Ω , R_L =3 Ω , | | 28.8 | | no | |
| Turn-Off Delay Time | t _{d(off)} | I_{DS} =20A | | 17 | | ns | |
| Turn-Off Fall Time | t _f | | | 28.6 | | | |

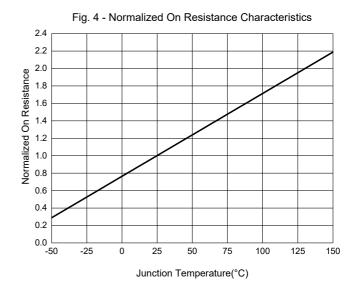


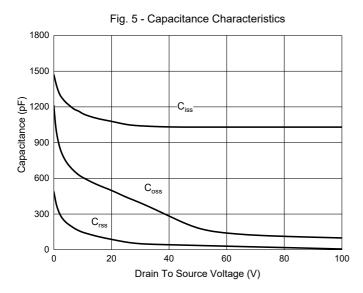
Curve Characteristics

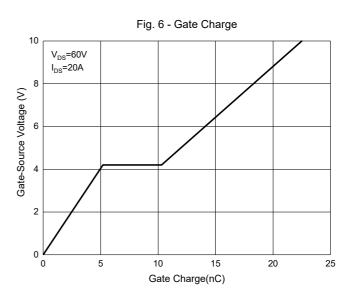






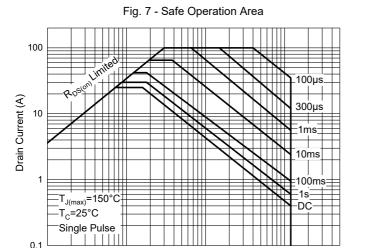








Curve Characteristics



Drain-Source Voltage (V)

Rev.3-3-12012020 4/5 MCCSEMI.COM

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Ordering Information

| Device | Packing | |
|----------------|-----------------------|--|
| Part Number-TP | Tape&Reel: 5Kpcs/Reel | |

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